## 5.0SMDJxxS Series

Single Chip Design





## **Additional Information**



Resources





Accessories

Samples

### **Agency Approvals**

Agency	Agency File Number
<i>71</i>	E230531

#### 

Parameter	Symbol	Value	Unit
Maximum Peak Pulse Power Dissipation at $T_L$ =25°C by 10/1000 $\mu$ s Waveform (Fig.2)(Note 1)(Note 2)	P <sub>PPM</sub>	5000	W
Power Dissipation on Infinite Heat Sink at $T_L$ =50°C (Note 4)	P <sub>D</sub>	6.5	W
Peak Forward Surge Current, 8.3ms Single Half Sine Wave (Note 3)	I <sub>FSM</sub>	300	А
Maximum Instantaneous Forward Voltage at 100A for Unidirectional Only	V <sub>F</sub>	3.5	V
Operating Temperature Range	$T_{J}$	-65 to 150	°C
Storage Temperature Range	T <sub>STG</sub>	-65 to 175	°C
Typical Thermal Resistance Junction to Lead	R <sub>eJL</sub>	15	°C/W
Typical Thermal Resistance Junction to Ambient	$R_{\theta JA}$	75	°C/W

#### Notes:

- 1. Non-repetitive current pulse , per Fig. 4 and derated above  $T_J$  (initial) =25°C per Fig. 3.
- 2. Voltage of 6.0V~60V products's peak pulse power dissipation is 5000W, and 64V and 70V is 4500W. Bidirectional products 33V~58V are also 4500W.
- 3. Measured on 8.3ms single half sine wave or equivalent square wave for unidirectional components only,duty cycle=4 per minute maximum.
- 4. Mounted on copper pad area of 0.31x0.31" (8.0 x 8.0mm) to each terminal.

## **Description**

The 5.0SMDJxxS series, single chip design is designed specifically to protect sensitive electronic equipment from voltage transients induced by lightning and other transient voltage events.

#### **Features**

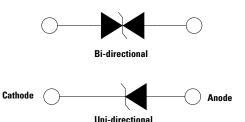
- 5000W peak pulse power capability at 10/1000µs waveform, repetition rate (duty cycles):0.01%
- Recognized to UL 497B as an Isolated Loop Circuit Protector
- DO214AB SMT package for minimized board space
- Low profile package
- Typical failure mode is short from over-specified voltage or current
- Whisker test is conducted based on JEDEC JESD201A per its table 4a and 4c
- ESD protection of data lines in accordance with IEC 61000-4-2, ESD 30kV (Air), 30kV (Contact)
- EFT protection of data lines in accordance with IEC 61000-4-4
- Built-in strain relief
- Glass passivated chip junction
- Very fast response time

- Excellent clamping capability
- Low incremental surge resistance
- Typical IR less than 2µA when VBR min>12V
- High temperature to reflow soldering guaranteed: 260°C/10sec
- VBR @TJ= VBR@25°C x (1+αT x (TJ - 25))(αT:Temperature Coefficient)
- UL Recognized compound meeting flammability rating V-0
- Meet MSL level1, per J-STD-020, LF maximun peak of 260°C
- Matte tin lead-free plated
- Halogen free and RoHS compliant
- Pb-free E3 means 2nd level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/JEDEC J-STD-609A.01)

## **Applications**

TVS components are ideal for the protection of I/O Interfaces, VCC bus and other vulnerable circuits used in Telecom, Computer, Industrial and Consumer electronic applications.

#### **Functional Diagram**





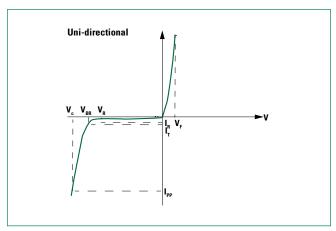
## **Electrical Characteristics** (T<sub>A</sub>=25°C unless otherwise noted)

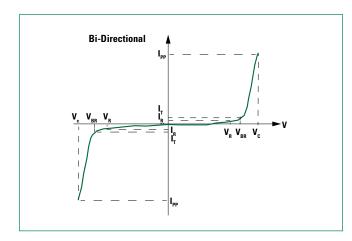
Part Number (Uni)	Part Number (Bi)	Mar	king	Reverse Stand off Voltage V <sub>R</sub>	do Vol V (Vo	eak- own tage / BR olts)	Test Cur- rent	Maximum Clamping Voltage VC @I <sub>pp</sub> (10/1000µs)	Maximum Peak Pulse Current I <sub>pp</sub> (10/1000µs)	Maximum Clamping Voltage	Maxi- mum Peak Pulse Current	Maxi- mum Re- verse Leak- age	Maxi- mum Tem- pera- ture coef-	Agency Ap- proval
		UNI	ВІ	(Volts)	Min	Max	(mA)	(V)	(A)	@ Ϊ́ <sub>PP</sub> (8/20μs) (V)	(8/20µs) (A)	I <sub>R</sub> @ V <sub>R</sub> (μΑ)	of V <sub>BR</sub> (%/C)	<b>7U</b>
5.0SMDJ6.0AS	5.0SMDJ6.0CAS	5PAB	5BAB	6.0	6.67	7.37	10	10.3	485.4	13.3	2669.7	0.008	0.046	X
5.0SMDJ6.5AS	5.0SMDJ6.5CAS	5PAE	5BAE	6.5	7.22	7.98	10	11.2	446.4	14.5	2455.2	500.0	0.052	X
5.0SMDJ7.0AS	5.0SMDJ7.0CAS	5PAF	5BAF	7.0		8.60	10	12.0	416.7	15.5	2291.9	200.0	0.058	X
	5.0SMDJ7.5CAS			7.5	8.33		1	12.9	387.6	16.7	2131.8	100.0	0.061	X
	5.0SMDJ8.0CAS			8.0		9.83	1	13.6	367.6	17.6	2021.8	50.0	0.064	X
	5.0SMDJ8.5CAS			8.5		10.4	1	14.4	347.2	18.6	1909.6	20.0	0.066	X
	5.0SMDJ9.0CAS			9.0	10.0		1	15.4	324.7	19.9	1785.9	10.0	0.069	X
5.0SMDJ10AS	5.0SMDJ10CAS			10.0		12.3	1	17.0	294.1	22.0	1617.6	5.0	0.071	X
5.0SMDJ11AS		5PAT		11.0		13.5	1	18.2	274.7	23.5	1510.9	2.0	0.074	X
5.0SMDJ12AS		5PAV		12.0		14.7	1	19.9	251.3	25.7	1382.2	2.0	0.075	X
5.0SMDJ13AS	5.0SMDJ13CAS			13.0		15.9	1	21.5	232.6	27.8	1279.3	2.0	0.076	X
5.0SMDJ14AS		5PAZ		14.0		17.2	1	23.2	215.5	30.0	1185.3	2.0	0.080	X
5.0SMDJ15AS	5.0SMDJ15CAS			15.0		18.5	1	24.4	204.9	31.5	1127.0	2.0	0.083	X
5.0SMDJ16AS	5.0SMDJ16CAS			16.0		19.7	1	26.0	192.3	33.6	1057.7	2.0	0.084	X
5.0SMDJ17AS	5.0SMDJ17CAS			17.0		20.9	1	27.6	181.2	35.7	996.6	2.0	0.085	X
5.0SMDJ18AS	5.0SMDJ18CAS			18.0		22.1	1	29.2	171.2	37.7	941.6	2.0	0.088	X
5.0SMDJ20AS	5.0SMDJ20CAS			20.0		24.5	1	32.4	154.3	41.9	848.7	2.0	0.091	X
5.0SMDJ22AS	5.0SMDJ22CAS			22.0	24.4		1	35.5	140.8	45.9	774.4	2.0	0.092	X
5.0SMDJ24AS	5.0SMDJ24CAS			24.0	26.7		1	38.9	128.5	50.3	706.8	2.0	0.092	X
5.0SMDJ26AS	5.0SMDJ26CAS			26.0	28.9		1	42.1	118.8	54.4	653.4	2.0	0.093	X
	5.0SMDJ28CAS			28.0		34.4	1	45.4	110.1	58.7	605.6	2.0	0.094	X
5.0SMDJ30AS	5.0SMDJ30CAS			30.0		36.8	1	48.4	103.3	62.5	568.2	2.0	0.096	X
5.0SMDJ33AS	-	5PCB	-	33.0		40.6	1	53.3	93.9	68.9	516.5	2.0	0.097	X
-	5.0SMDJ33CAS	-	5BCB	33.0		40.6	1	53.3	84.4	68.9	516.5	2.0	0.097	X
5.0SMDJ36AS	- E 0CMD 126CAC	5PCE	- EDCE	36.0		44.2	1	58.1	86.1	75.1	430.5	2.0	0.098	X
- E OCMD 140AC	5.0SMDJ36CAS	5PCF	5BCE	36.0		44.2	1	58.1	77.5	75.1	430.5	2.0	0.098	X
5.0SMDJ40AS	- E 0CMD 140CAC	SPCF	5BCF	40.0	44.4		1	64.5	77.6	83.3	388.0	2.0	0.099	X
5.0SMDJ43AS	5.0SMDJ40CAS	5PCG		40.0	44.4	52.8	1	64.5 69.4	69.8 72.1	83.3 89.7	388.0 360.5	2.0	0.099	X
5.031VID343A3	5.0SMDJ43CAS	or CG	- 5BCG	43.0		52.8	1	69.4	64.8	89.7	360.5	2.0	0.100	X
5.0SMDJ45AS	5.031VID043CA3	5PCK		45.0		55.3	1	72.7	68.8	93.9	344.0	2.0	0.100	X
5.03IVID345A3	5.0SMDJ45CAS	JF CK	5BCK	45.0		55.3	1	72.7	61.9	93.9	344.0	2.0	0.101	X
5.0SMDJ48AS		5PCM				58.9	1	77.4	64.7	100.0	323.5	2.0	0.101	X
5.05IVID540A5	5.0SMDJ48CAS					58.9	1	77.4	58.1	100.0	323.5	2.0	0.101	X
5.0SMDJ51AS	-	5PCP		51.0		62.7	1	82.4	60.7	106.5	303.5	2.0	0.101	X
-	5.0SMDJ51CAS		5BCP	51.0		62.7	1	82.4	54.6	106.5	303.5	2.0	0.101	X
5.0SMDJ54AS	-	5PCR				66.3	1	87.1	57.5	112.5	287.5	2.0	0.102	X
-	5.0SMDJ54CAS	-	5BCR			66.3	1	87.1	51.7	112.5	287.5	2.0	0.102	X
5.0SMDJ58AS	-	5PCT				71.2	1	93.6	53.5	120.9	267.5	2.0	0.102	X
- -	5.0SMDJ58CAS	-	5BCT			71.2	1	93.6	48.1	120.9	267.5	2.0	0.103	X
5.0SMDJ60AS	-	5PCV				73.7	1	96.8	51.7	125.1	258.5	2.0	0.103	X
5.0SMDJ64AS	_	5PCX		64.0		78.6	1	103.0	43.7	133.1	243.0	2.0	0.104	X
5.0SMDJ70AS	-	5PCZ				86.0	1	113.0	39.9	146.0	221.5	2.0	0.105	X

For bidirectional type having  $\rm V_{R}$  of 10 volts and less, the  $\rm I_{R}$  limit is double.



### **I-V Curve Characteristics**





 $\mathbf{P}_{_{\mathbf{PPM}}}$  Peak Pulse Power Dissipation – Max power dissipation

Stand-off Voltage -- Maximum voltage that can be applied to the TVS without operation

V<sub>RR</sub> Breakdown Voltage - Maximum voltage that flows though the TVS at a specified test current (I<sub>T</sub>)

**V**c **Clamping Voltage** – Peak voltage measured across the TVS at a specified Ippm (peak impulse current)

I<sub>R</sub> Reverse Leakage Current - Current measured at V<sub>R</sub>

V<sub>F</sub> Forward Voltage Drop for Uni-directional

## **Ratings and Characteristic Curves** ( $T_A$ = 25°C unless otherwise noted)

**Figure 1:** TVS Transients Clamping Waveform

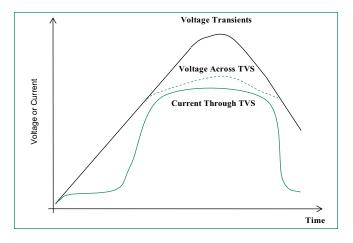
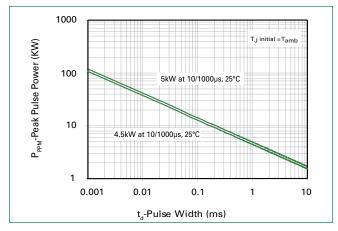


Figure 2: Peak Pulse Power Rating



**Figure 3:** Peak Pulse Power Derating Curve

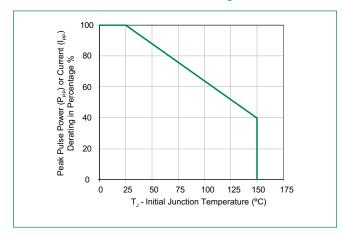


Figure 5:
Typical Junction Capacitance

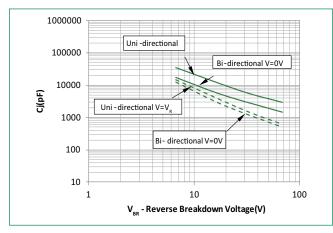
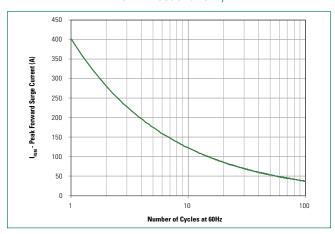
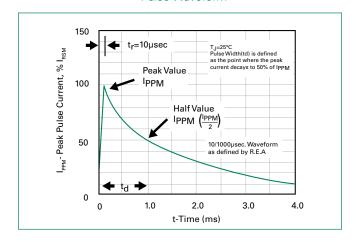


Figure 7:

Maximum Non-Repetitive Peak Forward Surge Current
Uni-Directional Only



**Figure 4:** Pulse Waveform



**Figure 6:**Typical Transient Thermal Impedance

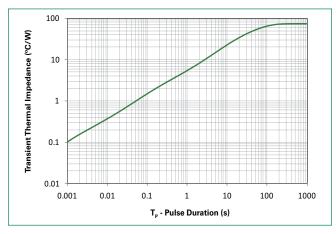
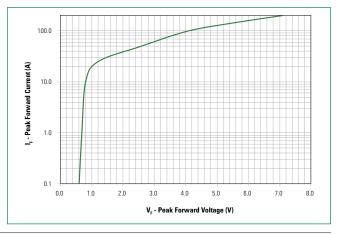


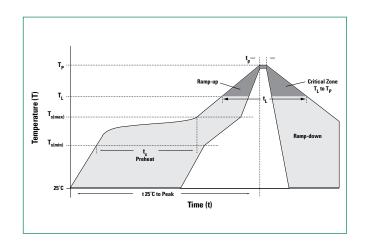
Figure 8:
Peak Forward Voltage Drop vs Peak Forward Current
(Typical Values)





## **Soldering Parameters**

Reflow Cond	dition	Lead-free assembly		
Pre Heat	-Temperature Min (T <sub>s(min)</sub> )	150°C		
	-Temperature Max (T <sub>s(max)</sub> )	200°C		
	-Time (min to max) (t <sub>L</sub> )	60 – 180 secs		
Average ram peak	np up rate (Liquidus Temp (T <sub>L</sub> ) to	3°C/second max		
$T_{\text{S(max)}}$ to $T_{\text{L}}$ -	Ramp-up Rate	3°C/second max		
Reflow	-Temperature (T <sub>L</sub> ) (Liquidus)	217°C		
	-Time (min to max) (t <sub>L</sub> )	60 - 150 seconds		
Peak Temper	rature (T <sub>P</sub> )	260 <sup>+0/-5</sup> °C		
Time within	5°C of actual peak Temperature ( $t_p$ )	20 - 40 seconds		
Ramp-down	Rate	6°C/second max		
Time 25°C to	peak Temperature (T <sub>p</sub> )	8 minutes Max.		
Do not exce	ed	260°C		



### **Physical Specifications**

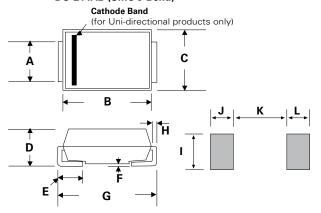
Weight	0.007 ounce, 0.21 grams
Case	JEDEC DO214AB. Molded compound body over glass passivated junction
Polarity	Color band denotes positive end (cathode) except for bidirectional versions.
Terminal	Matte Tin-plated leads, Solderable per JESD22-B102

### **Environmental Specifications**

High Temp. Storage	JESD22-A103
HTRB	JESD22-A108
Temperature Cycling	JESD22-A104
MSL	JEDEC-J-STD-020, Level 1
H3TRB	JESD22-A101
RSH	JESD22-A111

## **Dimensions**

## DO-214AB (SMC J-Bend)



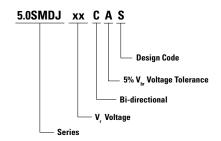
Dimensions	Inc	hes	Millimeters			
Dimensions	Min	Max	Min	Max		
Α	0.114	0.126	2.900	3.200		
В	0.260	0.280	6.600	7.110		
С	0.220	0.245	5.590	6.220		
D	0.079	0.103	2.060	2.620		
E	0.030	0.060	0.760	1.520		
F	-	0.008	-	0.203		
G	0.305	0.320	7.750	8.130		
Н	0.006	0.012	0.152	0.305		
1	0.129	-	3.300	-		
J	0.094	-	2.400	-		
K	-	0.165	-	4.200		
L	0.094	-	2.400	-		



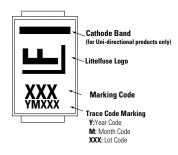
### **Packaging Options**

Part number	Component Package	Quantity	Packaging Option	Packaging Specification
5.0SMDJxxXXS	DO-214AB	3000	Tape & Reel - 16mm tape/13" reel	EIA STD RS-481

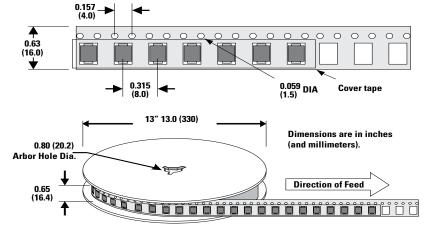
## **Part Numbering System**

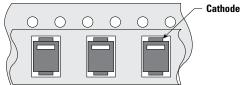


## **Part Marking System**



### **Tape and Reel Specification**





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